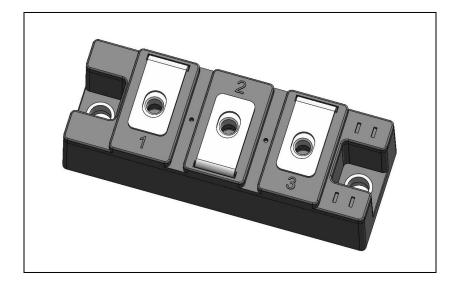
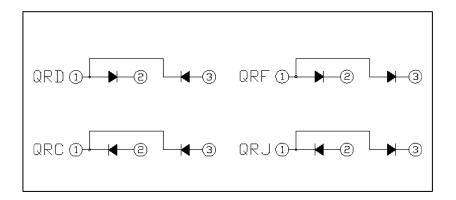


Powerex, Inc., 173 Pavilion Lane, Youngwood, Pennsylvania 15697 (724) 925-7272 www.pwrx.com

Silicon Carbide Schottky Diode Modules 130 Amperes / 1200 Volts



# Dual SiC Diode Module 130 Amperes / 1200 Volts



### **Description:**

Powerex Silicon Carbide Dual Schottky Diode Modules are designed for use in applications requiring extremely fast switching. The modules are isolated for easy mounting with other components on common heatsinks.

#### Features:

- ☐ Junction Temperature: 175°C
   ☐ Extremely Fast Switching
   ☐ Zero Reverse Recovery
   ☐ Zero Forward Recovery
   ☐ High Frequency Operation
   ☐ Positive Temperature Coefficient on On-State Voltage (V<sub>F</sub>)
   ☐ RoHS Compliant
   ☐ Isolated Mounting
   ☐ Metal Baseplate
   ☐ Low Thermal Impedance

**Applications:** 

☐ 3500V Isolation Voltage☐ Aluminum Nitride Isolation

- ☐ Energy Saving Power Systems☐ High Frequency Type Power Systems☐ High Temperature Power Systems
- ☐ Welding Converters
- ☐ Motor Control



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## Absolute Maximum Ratings, $T_j = 25^{\circ}C$ unless otherwise specified

Characteristics	Symbol	QR_1213SA1	Units
Repetitive Peak Reverse Blocking Voltage	$V_{RRM}$	1200	Volts
Non-Repetitive Peak Reverse Blocking Voltage	$V_{RSM}$	1200	Volts
DC Current, TC = 80°C (Resistive Load) *2	$I_{F(DC)}$	130	Amperes
Non-Repetitive Forward Surge Current	I <sub>FSM</sub>	260	Amperes
l²t for Fusing for One Cycle (t = 8.3mS, 100% VRRM Reapplied)	I²t	TBD	Amperes
Maximum Power Dissipation (T <sub>C</sub> =25°C, T <sub>J</sub> < 175°C) *1	$P_D$	319	Watts
Maximum Junction Temperature	$T_{Jmax}$	175	°C
Operating Junction Temperature, Continuous operation (under switching)	T <sub>j op</sub>	-40 to 150	°C
Maximum Case Temperature*1	T <sub>c max</sub>	125	°C
Storage Temperature	T <sub>stg</sub>	-40 to 125	°C
Mounting Torque, M6 Mounting Screws		5	Nm
Terminal Torque, M6 Terminal Screws		3.5	Nm
Module Weight (Typical)		180	Grams
Isolation Voltage	V <sub>ISO</sub>	3500	Volts

<sup>\*1</sup> Case temperature (T<sub>c</sub>) and heat sink temperature (T<sub>s</sub>) are defined on the each surface (mounting side) of base plate and heat sink under the chips.
\*2 Pulse width and repetition rate should be such that device junction temperature (T<sub>J</sub>) does not exceed T<sub>J (MAX)</sub> rating.

#### DC Characteristics, T<sub>J</sub>=25°C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Reverse Leakage Current	I <sub>RRM</sub>	Rated V <sub>RRM</sub>	-	-	1.2	mA
Forward Voltage (Chip)	V <sub>FM</sub>	$I_F=130A, T_J=25^{\circ}C$	=	1.53	-	Volts
Tolward Voltage (Chip)	V FM	I <sub>F</sub> =130A, T <sub>J</sub> = 125°C	-	2.05	-	Volts
Total Capacitive Charge	Q <sub>C</sub>	V <sub>R</sub> =600V	=	TBD	=	nC
Total Capacitance	С _	V <sub>R</sub> =400V, f = 1MHz	=	TBD - pF		
тотан Сараспансе	· _	$V_R=800V$ , $f=1MHz$	-	TBD	-	pF
Stray Inductance	Ls	P-N	-	10	-	nΗ

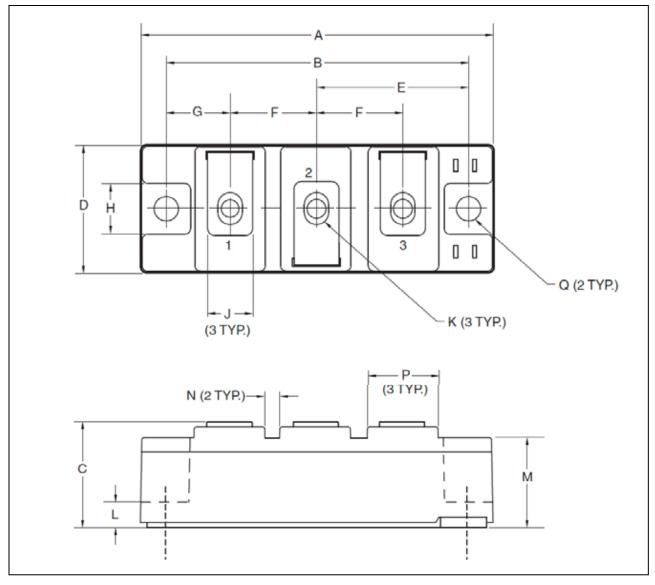
### **Thermal Resistance Characteristics**

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Thermal Resistance, Junction to Case	$R_{\text{th(j-c)}}$	Per Diode	-	-	0.47	°C/W
Contact Thermal Resistance	R <sub>th(c-s)</sub>	Per Module, Thermal Grease Applied	-	0.07	-	°C/W



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Dimensions	Millimeters	Dimensions	Millimeters
А	94	J	12
В	80	K	M6
С	30	L	7.5
D	34	M	25.4
E	40	N	4
F	23	Р	19
G	17	Q	6.5 Dia.
Н	13		